



15V NPN LOW SATURATION SWITCHING TRANSISTOR IN SOT26

Features

- BV_{CEO} > 15V
- I_C = 4A Continuous Collector Current
- I_{CM} = 13A Peak Pulse Current
- R_{CE(SAT)} = 50mΩ for a Low Equivalent On-Resistance
- Low Saturation Voltage (70mV max @ 1A)
- h_{FE} Characterized up to 12A
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.015 grams (Approximate)

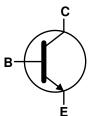
Applications

- DC–DC Converters
- Power Management Functions
- Power Switches
- Motor Control

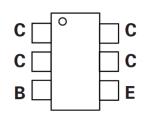
SOT26



Top View



Device Symbol



Top View Pin-Out

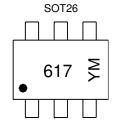
Ordering Information (Note 4)

| Product | Compliance | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---------------|------------|---------|--------------------|-----------------|-------------------|
| ZXT10N15DE6TA | AEC-Q101 | 617 | 7 | 8 | 3,000 |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



 $\begin{array}{l} 617 = Product\ Type\ Marking\ Code \\ YM = Date\ Code\ Marking \\ Y\ or\ \overline{Y} = Year\ (ex:\ C=2015) \\ M\ or\ \overline{M} = Month\ (ex:\ 9=September) \end{array}$

Date Code Key

| Year | 201 | 5 | 2016 | 2017 | 2018 | 2019 | 2020 | 202 | 1 20 | 22 2 | 2023 | 2024 | 2025 |
|-------|-----|-----|------|------|------|------|------|-----|------|------|------|------|------|
| Code | С | | D | Е | F | G | Н | | , | J | K | L | М |
| Month | 1 | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V_{CBO} | 15 | V |
| Collector-Emitter Voltage | V _{CEO} | 15 | V |
| Emitter-Base Voltage | V _{EBO} | 5 | V |
| Base Current | I _B | 500 | mA |
| Continuous Collector Current | Ic | 4 | Α |
| Peak Pulse Collector Current | Ісм | 13 | Α |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|---|-----------------------------------|------------------|-------------|-------|
| Power Dissipation | (Note 5) | | 1.1 8.8 | W |
| Linear Derating Factor | (Note 6) | - P _D | 1.7 13.6 | mW/°C |
| Thermal Designation to Ambient | (Note 5) | Б | 113 | |
| Thermal Resistance, Junction to Ambient | (Note 6) | $R_{	hetaJA}$ | 73 | °C/W |
| Thermal Resistance, Junction to Lead (Note 7) | | $R_{	heta JL}$ | 18.6 | |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C | |

ESD Ratings (Note 8)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

Notes:

^{5.} For a device mounted with the collector lead on 25mm x 25mm 1oz copper that is on single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

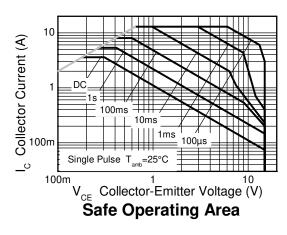
^{6.} Same as Note 6, except the device is measured at $t \le 5$ sec.

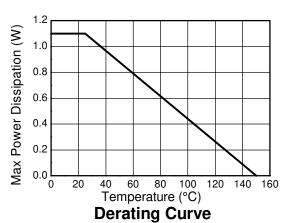
^{7.} Thermal resistance from junction to solder-point (at the end of the collector lead).

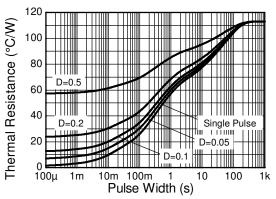
8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information







Transient Thermal Impedance



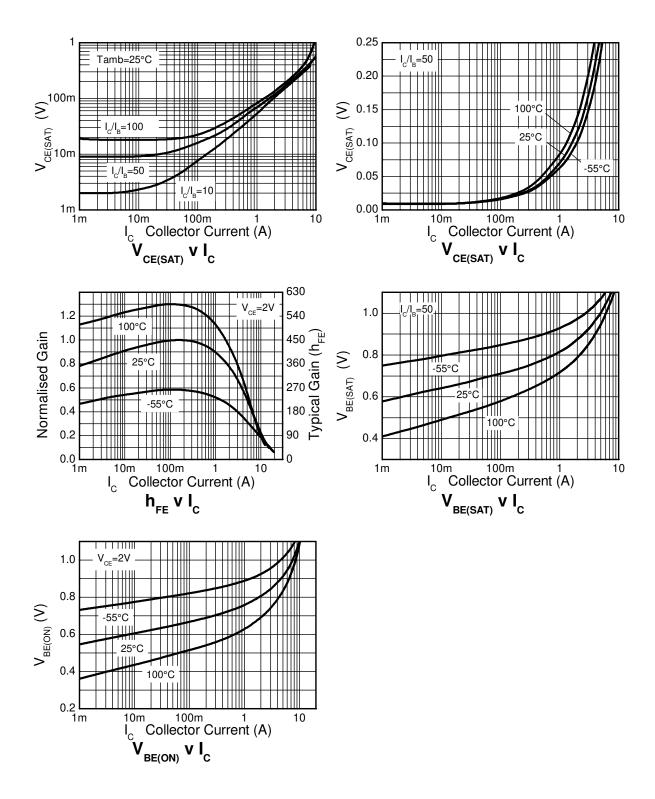
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|----------------------|-----|------|------|------|--|
| OFF CHARACTERISTICS | | | | | | |
| Collector-Base Breakdown Voltage | | 15 | 70 | _ | V | $I_C = 100\mu A$ |
| Collector-Emitter Breakdown Voltage (Note 9) | | 15 | 18 | _ | V | I _C = 10mA |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 5 | 8.2 | _ | V | I _E = 100μA |
| Collector-Base Cutoff Current | I _{CBO} | _ | _ | 100 | nA | V _{CB} = 10V |
| Emitter Cutoff Current | I _{EBO} | _ | _ | 100 | nA | V _{EB} = 4V |
| Collector-Emitter Cutoff Current | I _{CES} | _ | _ | 100 | nA | V _{CES} = 10V |
| ON CHARACTERISTICS (Note 9) | | | | | | |
| | | 200 | 415 | _ | | $I_C = 10mA$, $V_{CE} = 2V$ |
| | | 300 | 450 | _ | | $I_C = 0.2A, V_{CE} = 2V$ |
| DC Current Gain | h _{FE} | 200 | 320 | _ | _ | I _C = 3A, V _{CE} = 2V |
| | | 150 | 240 | _ | | I _C = 5A, V _{CE} = 2V |
| | | _ | 80 | _ | | I _C = 12A, V _{CE} = 2V |
| | ., | _ | 8 | 14 | mV | I _C = 100mA, I _B = 10mA |
| Callacter Freitter Catrination Vallage | | _ | 70 | 100 | | $I_C = 1A, I_B = 10mA$ |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | _ | 165 | 200 | | I _C = 3A, I _B = 50mA |
| | | _ | 230 | 260 | | I _C = 4A, I _B = 50mA |
| Base-Emitter Turn-On Voltage | V _{BE(sat)} | _ | 0.94 | 1 | V | I _C = 4A, I _B = 50mV |
| Base-Emitter Turn-On Voltage | V _{BE(on)} | _ | 0.87 | 0.95 | V | I _C = 4A, V _{CE} = 2V |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Current Gain-Bandwidth Product | f⊤ | 80 | 120 | _ | MHz | V _{CE} = 10V, I _C = 50mA, f = 100MHz |
| Output Capacitance | C _{obo} | _ | 30 | 40 | pF | V _{CB} = 10V, f = 1MHz |
| Turn-On Time | t _(on) | _ | 120 | _ | ns | V _{CC} = 10V, I _C = 3A |
| Turn-Off Time | t _(off) | _ | 160 | _ | ns | $I_{B1} = I_{B2} = 50 \text{mA}$ |

Note: 9. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



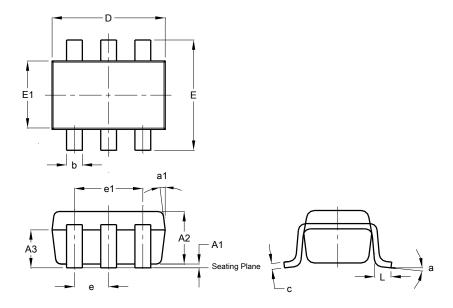
Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)





Package Outline Dimensions

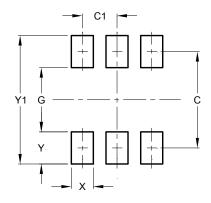
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| | SOT26 | | | | | | |
|----------------------|-------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| A 1 | 0.013 | 0.10 | 0.05 | | | | |
| A2 | 1.00 | 1.30 | 1.10 | | | | |
| А3 | 0.70 | 0.80 | 0.75 | | | | |
| b | 0.35 | 0.50 | 0.38 | | | | |
| С | 0.10 | 0.20 | 0.15 | | | | |
| D | 2.90 | 3.10 | 3.00 | | | | |
| е | - | - | 0.95 | | | | |
| e1 | - | - | 1.90 | | | | |
| Е | 2.70 | 3.00 | 2.80 | | | | |
| E1 | 1.50 | 1.70 | 1.60 | | | | |
| L | 0.35 | 0.55 | 0.40 | | | | |
| а | - | - | 8° | | | | |
| a1 | - | - | 7° | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 2.40 |
| C1 | 0.95 |
| G | 1.60 |
| Х | 0.55 |
| Υ | 0.80 |
| V1 | 3 20 |



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